

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
WENHUI LI	07/30/2014
HEJING ZHANG	07/30/2014
LONGQIANG SHI	07/30/2014
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Property Type	Number
Application Number:	14381945
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Total Attachments: 2	
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ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

1st Name: LI, Wenhui
Residing at Shenzhen City, Guangdong, China

2nd Name: ZHANG, Hejing
Residing at Shenzhen City, Guangdong, China

3rd Name: SHI, Longqiang
Residing at Shenzhen City, Guangdong, China

hereby sell(s), assign(s) and transfer(s) unto:

SHENZHEN CHINA STAR OPTOELECTRONICS TECHNOLOGY CO., LTD. of
NO. 9-2, Tangming Road, Guangming district of Shenzhen, Guangdong 518132, China

(hereinafter referred as "ASSIGNEE"), its successors and assigns, the entire right, title and

interest in and to the invention known as

MANUFACTURING METHOD AND STRUCTURE OF THIN FILM TRANSISTOR BACKPLANE

hereinafter referred as "INVENTION"), for which a United States Patent Application was

executed concurrently herewith or, if not so executed, was:

- a. ☐ executed on _____;
b. ☐ filed on _____, Application Serial No. _____; or
c. ☒ established by PCT International Patent Application No. PCT/CN2014/082123

an application for Letters Patent of United States of America.

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

Signature of
1st Inventor LI Wenhui Executed Date 2014/07/30

Signature of
2nd Inventor ZHANG Hejing Executed Date 2014/07/30

Signature of
3rd Inventor SHI Longgang Executed Date 2014/07/30